Analog high linearity low noise variable gain amplifierRev. 1 — 10 August 2012Preliminary data sheet

1. Product profile

1.1 General description

The BGU7062 is a fully integrated analog-controlled variable gain amplifier module. Its low noise and high linearity performance makes it ideal for sensitive receivers in cellular base station applications. The BGU7062 is operating in the 1710 MHz to 1785 MHz frequency range and has a gain control range of 35 dB. At maximum gain the noise figure is 0.85 dB. The gain is analog-controlled having maximum gain at 0 V and minimum gain at 3.3 V. The LNA can be bypassed extending the dynamic range. The BGU7062 is internally matched to 50 ohm, meaning no external matching is required, enabling ease of use. It is housed in a 16 pins 8 mm \times 8 mm \times 1.3 mm leadless HLQFN16R package SOT1301.

1.2 Features and benefits

- Input and output internally matched to 50 Ω
- Low noise figure of 0.85 dB
- High input IP3 of 0.8 dBm
- High P_{i(1dB)} of −12.8 dBm
- Bypass mode of LNA giving high dynamic gain range
- Gain control range of 0 dB to 35 dB
- Single 5 V supply
- Single analog gain control of 0 V to 3.3 V
- Unconditionally stable up to 12.75 GHz
- Moisture sensitivity level 3
- ESD protection at all pins

1.3 Applications

- Cellular base stations, remote radio heads
- 3G, LTE infrastructure
- Low noise applications with variable gain and high linearity requirements
- Active antenna



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1.4 Quick reference data

Table 1. Quick reference data

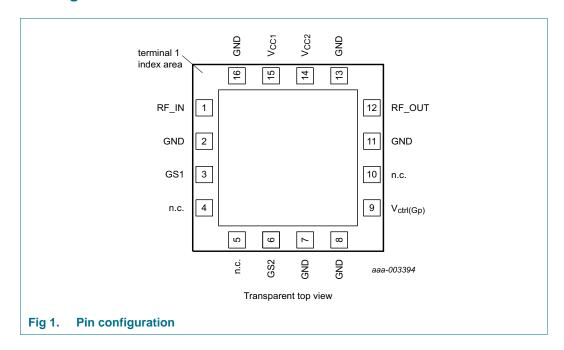
 $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 1750 MHz; $T_{amb} = 25 \text{ °C}$; input and output 50 Ω ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CC(tot)}	total supply current	high gain mode	[1]	190	220	250	mA
		low gain mode	[2]	165	190	215	mA
NF	noise figure	$V_{ctrl(Gp)} = 0 V$ (maximum power gain)	[1]	-	0.85	-	dB
		G _p = 35 dB	[1]	-	0.95	1.1	dB
IP3 _I	input third-order intercept point	G_p = 35 dB; 2-tone; tone-spacing = 1.0 MHz	[1]	0	0.8	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	$G_p = 35 \text{ dB}$	<u>[1]</u>	-14	-12.8	-	dBm

[1] high gain mode: GS1 = LOW; GS2 = HIGH (see Table 9)

[2] low gain mode: GS1 = HIGH; GS2 = LOW (see <u>Table 9</u>)

2. Pinning information



2.1 Pinning

2.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
RF_IN	1	RF input
GND	2, 7, 8, 11, 13, 16	ground
GS1	3	gain switch control 1
n.c.	4, 5, 10	not connected
GS2	6	gain switch control 2

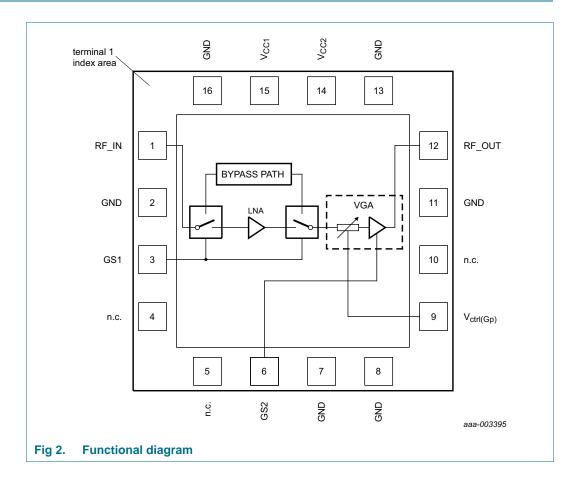
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Table 2.	Pin description continued	
Symbol	Pin	Description
V _{ctrl(Gp)}	9	power gain control voltage
RF_OUT	12	RF output
V _{CC2}	14	supply voltage 2
V _{CC1}	15	supply voltage 1

3. Ordering information

Table 3. Ordering information							
Type number	Package	Package					
	Name	Description	Version				
BGU7062	HLQFN16R	plastic thermal enhanced low quad flat package; no leads; 16 terminals; body $8 \times 8 \times 1.3$ mm	SOT1301-1				

4. Functional diagram



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5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{CC}	supply voltage			0	6	V
V _{ctrl(Gp)}	power gain control voltage			-1	+3.6	V
V _{I(GS1)}	input voltage on pin GS1			-1	+3.6	V
V _{I(GS2)}	input voltage on pin GS2			-1	+3.6	V
P _{i(RF)CW}	continuous waveform RF input power	high gain mode; $V_{ctrl(Gp)} = 0 V$	[1]	-	10	dBm
		low gain mode; $V_{ctrl(Gp)} = 0 V$	[2]	-	15	dBm
Tj	junction temperature			-	150	°C
T _{stg}	storage temperature			-40	+150	°C
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM); according to ANSI/ESDA-JEDEC JS-001-2020-Device Testing, Human Body Model		-	±2	kV
		Charged Device Model (CDM); according to JEDEC standard 22-C101		-	±750	V

[1] high gain mode: GS1 = LOW; GS2 = HIGH (see Table 9)

[2] low gain mode: GS1 = HIGH; GS2 = LOW (see Table 9)

6. Recommended operating conditions

Table 5.	Recommended operating conc	litions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC1}	supply voltage 1		4.75	5	5.25	V
V _{CC2}	supply voltage 2		4.75	5	5.25	V
V _{ctrl(Gp)}	power gain control voltage		0	-	3.3	V
V _{I(GS1)}	input voltage on pin GS1		0	-	3.3	V
V _{I(GS2)}	input voltage on pin GS2		0	-	3.3	V
Z ₀	characteristic impedance		-	50	-	Ω
T _{case}	case temperature		-40	-	+85	°C

7. Thermal characteristics

Table 6.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-case)}	thermal resistance from junction to case		<u>[1]</u> 42	K/W

[1] The case temperature is measured at the ground solder pad.

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8. Characteristics

Table 7. Characteristics high gain mode

GS1 = LOW; GS2 = HIGH (see <u>Table 9</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 1750 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I _{CC(tot)}	total supply current		190	220	250	mΑ
G _{p(min)}	minimum power gain	V _{ctrl(Gp)} = 3.3 V	-	13.5	-	dB
G _{p(max)}	maximum power gain	V _{ctrl(Gp)} = 0 V	-	37	-	dB
G _{p(flat)}	power gain flatness	1710 MHz $\leq f \leq$ 1785 MHz; 18 dB $\leq G_p \leq$ 35 dB	-	0.3	-	dB
NF	noise figure	$V_{ctrl(Gp)} = 0 V$ (maximum power gain)	-	0.85	-	dB
		G _p = 35 dB	-	0.95	1.1	dB
		G _p = 18 dB	-	5.80	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz				
		G _p = 35 dB	0	0.8	-	dBm
		$G_p = 30 \text{ dB}$	-	3.2	-	dBm
		G _p = 29 dB	-	3.5	-	dBm
		G _p = 18 dB	-	5.0	-	dBm
P _{i(1dB)}	input power at 1 dB gain compression	G _p = 35 dB	-14	-12.8	-	dBm
		$G_p = 30 \text{ dB}$	-	-7.5	-	dBm
		G _p = 29 dB	-	-7.0	-	dBm
		G _p = 18 dB	-	-5.9	-	dBm
RL _{in}	input return loss	$V_{ctrl(Gp)} = 0 V$ (maximum power gain)	-	30	-	dB
		G _p = 35 dB	-	25	-	dB
RL _{out}	output return loss	$V_{ctrl(Gp)} = 0 V$ (maximum power gain)	-	17	-	dB
K	Rollett stability factor	$0 \text{ GHz} \le f \le 12.75 \text{ GHz}$	1	-	-	

Table 8. Characteristics low gain mode

GS1 = HIGH; GS2 = LOW (see <u>Table 9</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 1750 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC(tot)}	total supply current		165	190	215	mA
G _{p(min)}	minimum power gain	V _{ctrl(Gp)} = 3.3 V	-	-6.6	-	dB
G _{p(max)}	maximum power gain	V _{ctrl(Gp)} = 0 V	-	18.6	-	dB
G _{p(flat)}	power gain flatness	1710 MHz \leq f \leq 1785 MHz; 3 dB \leq G_{p} \leq 17 dB	-	0.1	-	dB
NF	noise figure	G _p = 17 dB	-	9.8	-	dB
		G _p = 3 dB	-	20.6	-	dB
IP3 _I	input third-order intercept point	2-tone; tone-spacing = 1.0 MHz			-	
		$G_p = 17 \text{ dB}$	-	20	-	dBm
		$G_p = 12 \text{ dB}$	-	24	-	dBm
		G _p = 11 dB	-	25	-	dBm
		$G_p = 3 dB$	-	28	-	dBm

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Table 8. Characteristics low gain mode ...continued

GS1 = HIGH; GS2 = LOW (see <u>Table 9</u>); $V_{CC1} = 5 V$; $V_{CC2} = 5 V$; f = 1750 MHz; $T_{amb} = 25 °C$; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

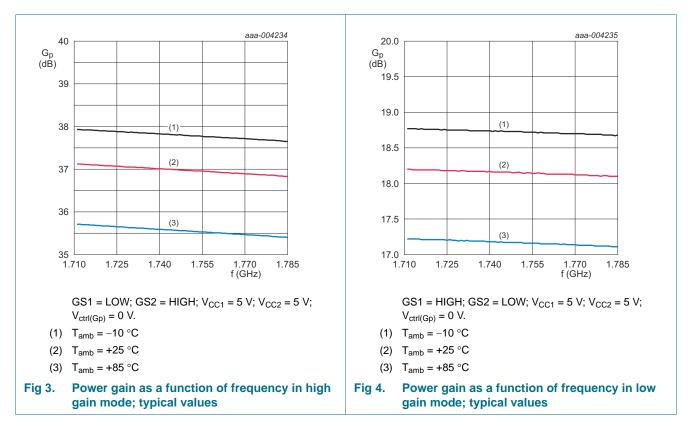
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P _{i(1dB)}	input power at 1 dB gain compression	$G_p = 17 \text{ dB}$	-	6.0	-	dBm
		G _p = 12 dB	-	10.0	-	dBm
		G _p = 11 dB	-	10.5	-	dBm
		G _p = 3 dB	-	10.5	-	dBm
RL _{in}	input return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	30	-	dB
		G _p = 17 dB	-	25	-	dB
RL _{out}	output return loss	V _{ctrl(Gp)} = 0 V (maximum power gain)	-	18	-	dB
K	Rollett stability factor	$0 \text{ GHz} \leq f \leq 12.75 \text{ GHz}$	1	-	-	
-						

Table 9.Gain switch truth table

 $V_{CC1} = 5 V; V_{CC2} = 5 V; -10 \ ^{\circ}C \le T_{amb} \le +85 \ ^{\circ}C$

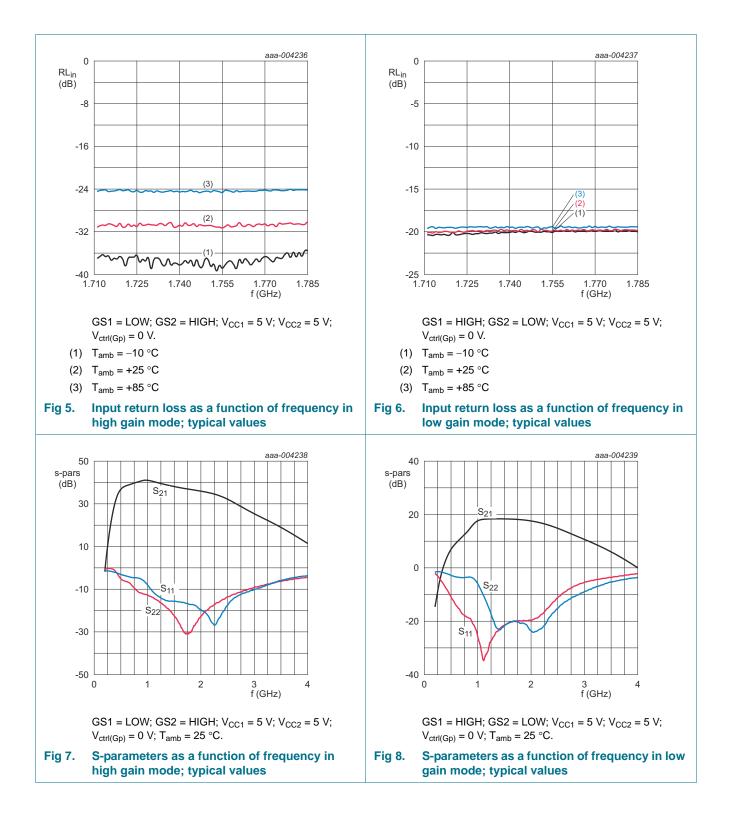
Gain mode	GS1		GS2			
	logic	V _{GS1}	logic	V _{GS2}		
high gain mode	LOW	0 V to 0.5 V	HIGH	2 V to 3.3 V		
low gain mode	HIGH	2 V to 3.3 V	LOW	0 V to 0.5 V		

8.1 Graphs



BGU7062

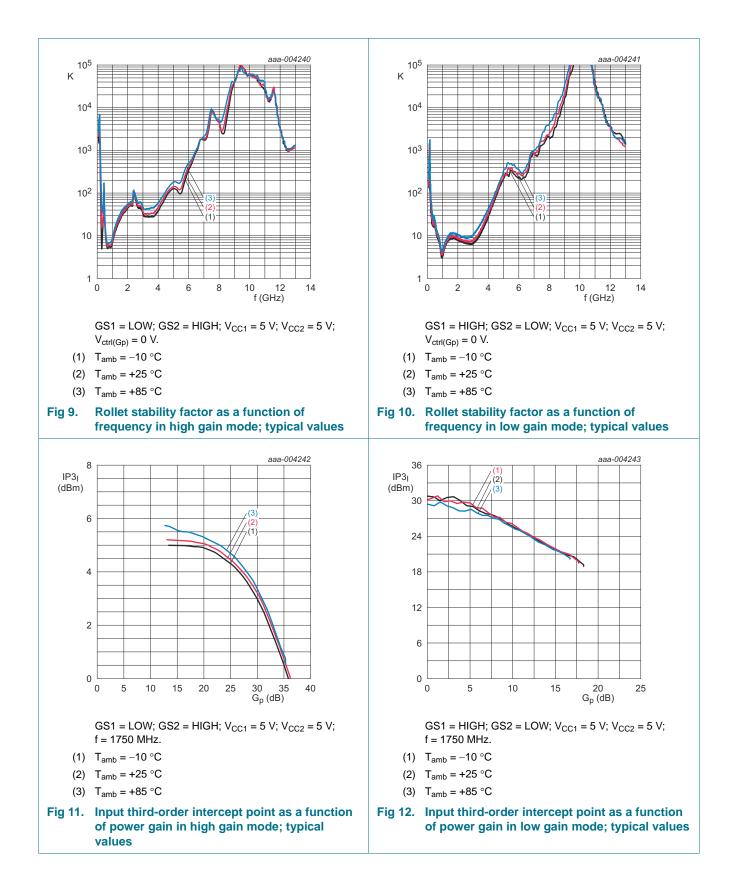
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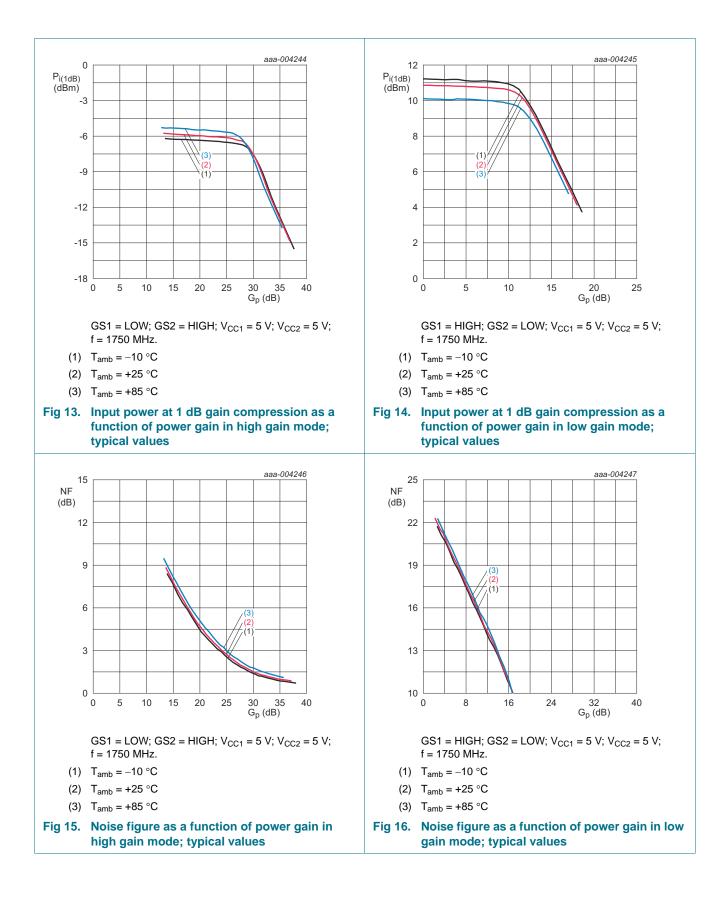
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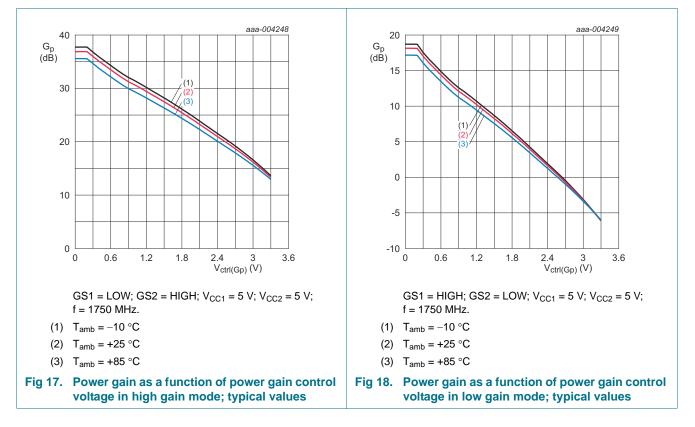
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9. Application information

Table 10. List of components For application circuit see Figure 19

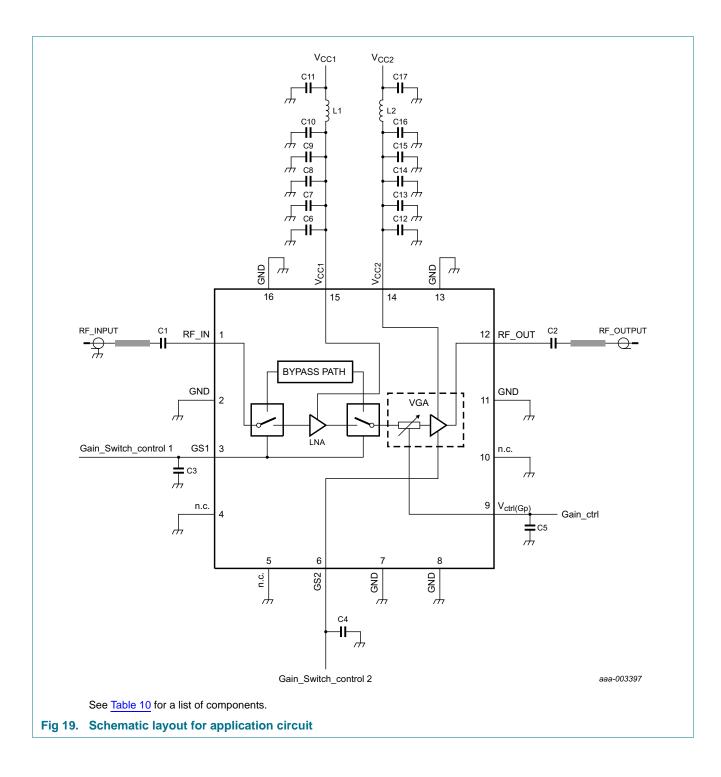
	ee <u>Figure 19</u> .			
Component	Description	Value		Remarks
C1, C2	capacitor	1 nF	[1]	0402
C3, C4, C5, C6, C12	capacitor	100 pF	[1]	0402
C7, C8, C9, C10,	capacitor	optional		
C11, C17	capacitor	100 nF	[1]	0402
C13, C14, C15, C16	capacitor	optional		
L1, L2	inductor	10 nH	[2]	0402

[1] Murata GRM1555 series.

[2] Murata LQG15 series.

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10. Package outline

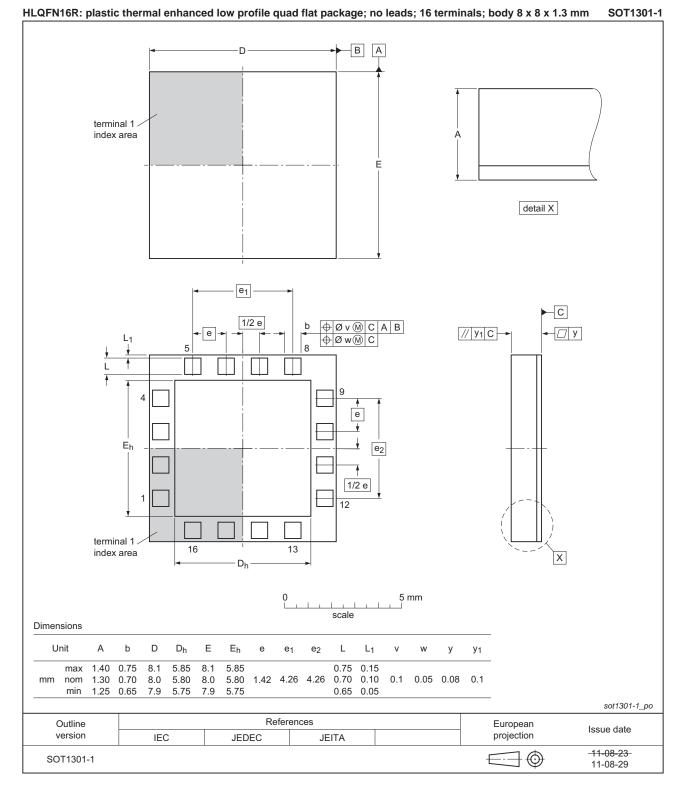


Fig 20. Package outline SOT1301-1 (HLQFN16R)

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11. Abbreviations

Table 11. Abbreviations			
Acronym	Description		
3G	3rd Generation		
ESD	ElectroStatic Discharge		
LNA	Low Noise Amplifier		
LTE	Long Term Evolution		

12. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGU7062 v.1	20120810	Preliminary data sheet	-	-

13. Legal information

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